



# MX573BBB312M500

## Ultra-Low Jitter 312.5MHz LVDS XO

### ClockWorks® FUSION

### General Description

The MX573BBB312M500 is an ultra-low phase jitter XO with LVDS output optimized for high line rate applications.

### Applications

- 10/40/400 Gigabit Ethernet
- Fibre Channel 10G/12G SERDES

### Absolute Maximum Ratings<sup>1</sup>

Supply Voltage (VIN).....	+4.6V
Lead Temperature (soldering, 10s).....	260°C
Case Temperature.....	115°C
Storage Temperature (T <sub>g</sub> ).....	-65°C to +125°C
ESD Machine Model.....	200V
ESD Rating (HBM).....	2kV

### Electrical Characteristics

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, outputs terminated with 100 Ohms between Q and /Q.<sup>3</sup>

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
IDD	Supply Current			90	100	mA
F0	Center Frequency			312.5		MHz
	Frequency Stability	Note 4			±50	ppm
∅j	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		149 99		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		100		400	ps
	Duty Cycle		45		55	%
VOH	Output High Voltage VOH max = VCM max + 1/2 VOD max	LVDS output levels	1.248	1.375	1.602	V
VOL	Output Low Voltage VOL min = VCM min - 1/2 VOD max	LVDS output levels	0.898	1.025	1.252	V
VOD	Output Differential Voltage		247	350	454	mV
VCM	Common Mode Output Voltage		1.125	1.2	1.375	V

#### Notes:

1. Exceeding the absolute maximum ratings may damage the device.
2. The device is not guaranteed to function outside its operating ratings.
3. Guaranteed after thermal equilibrium.
4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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### Features

- 312.5MHz LVDS
- Typical phase noise:
  - 99fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 7mm x 5mm LGA package

### Operating Ratings<sup>2</sup>

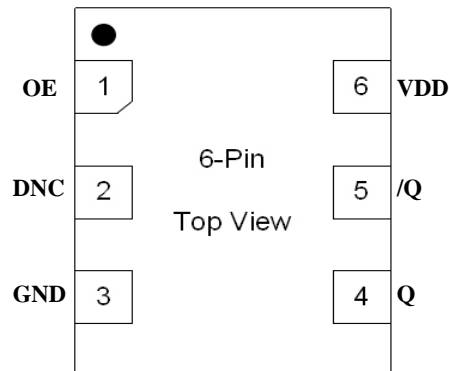
Supply Voltage (VIN).....	+2.375V to +3.63V
Ambient Temperature (TA).....	-40°C to +85°C
Junction Thermal Resistance	
LGA (T <sub>jc</sub> ) Still Air.....	53°C/W

## Ordering Information

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX573BBB312M500	MX573BB	B312M500	Tube	6-Pin 7mm x 5mm LGA
MX573BBB312M500-TR	MX573BB	B312M500	Tape and Reel	6-Pin 7mm x 5mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

## Pin Configuration



## Pin Description

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVC MOS	Output Enable, disables output to tri-state, 0 = Disabled, 1 = Enabled, 50k Ohms Pull-Up (Internal)
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	LVDS	Clock Output Frequency = 312.5MHz
6	VDD	PWR		Power Supply

## Environmental Specifications

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition C
Mechanical Vibration	MIL-STD-883, Method 2007, Condition A
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS / Green Compliant
Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10 <sup>-8</sup> atm cc/s
MSL Level	Crystal - MSL-1, Package MSL-3
Solvent Resistance	MIL-STD-202, Method 215

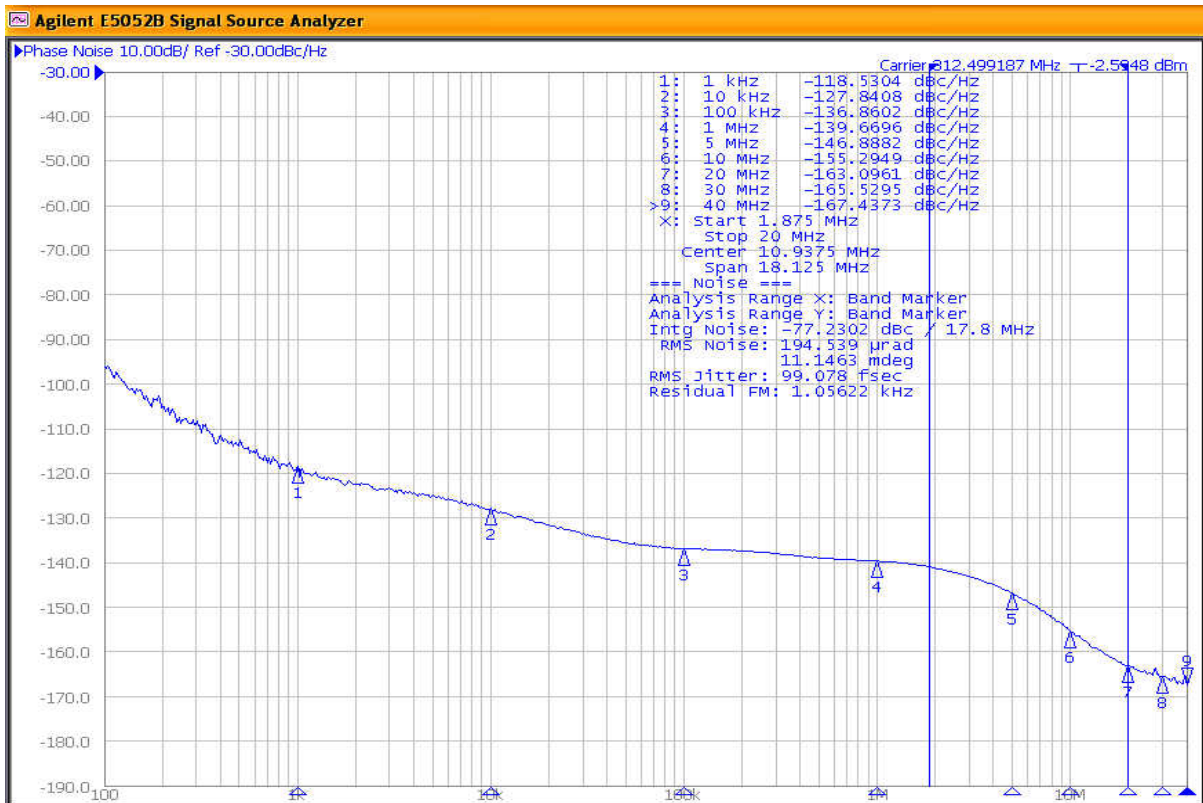


Figure 1. LVDS Output 312.5MHz 1.875MHz-20MHz 99fs

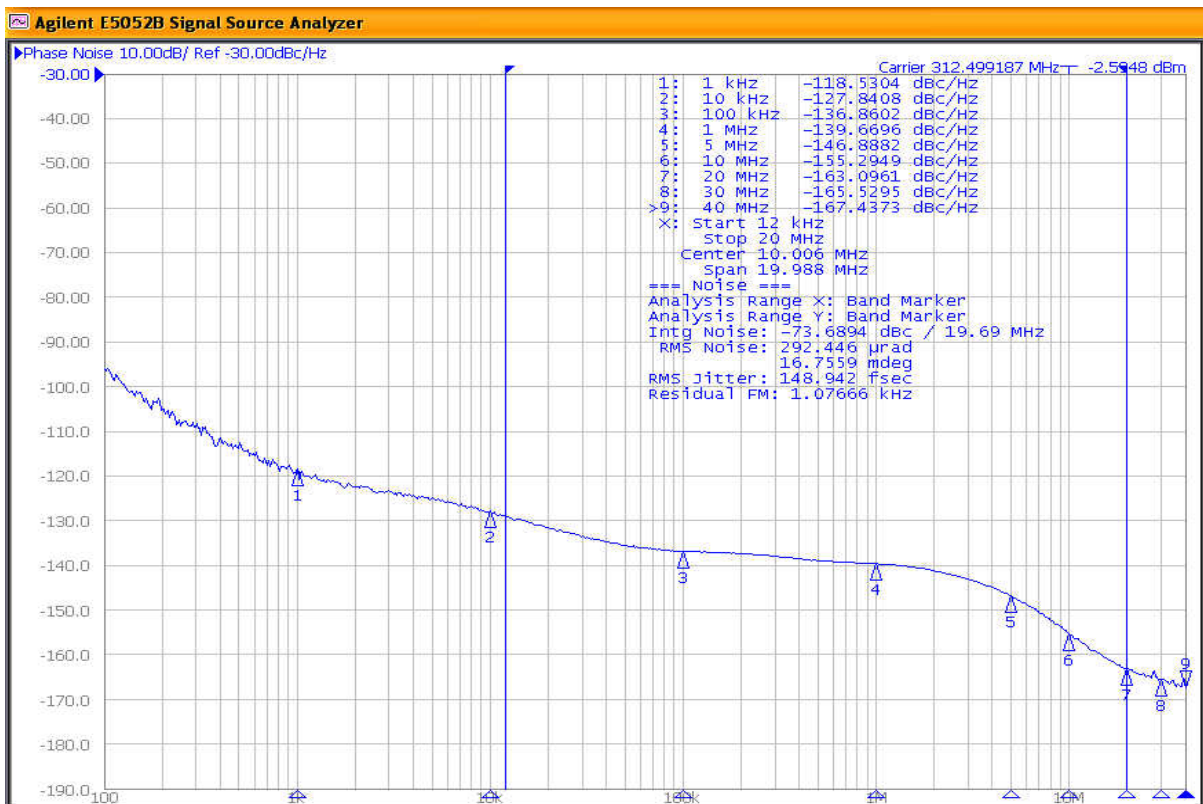
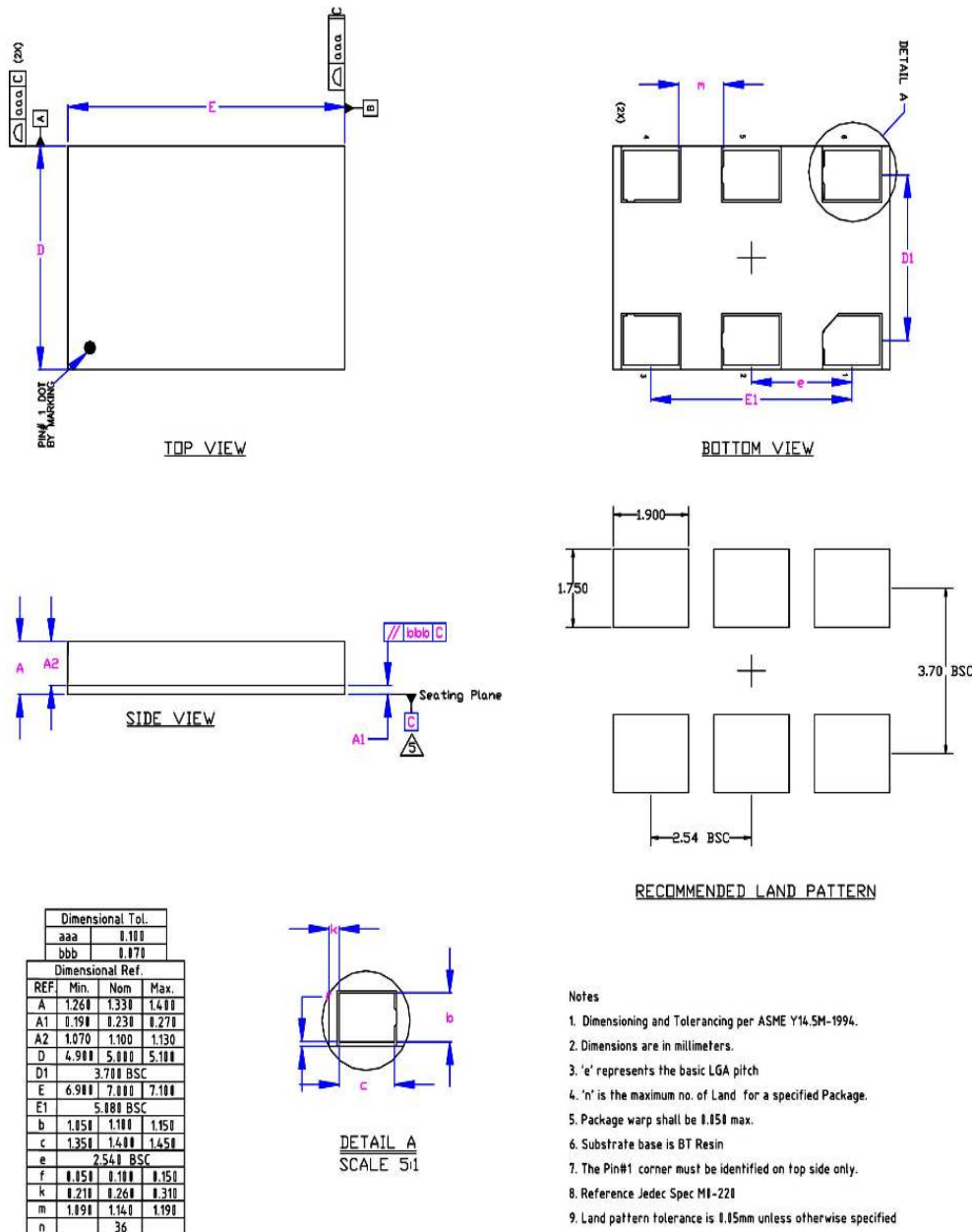


Figure 2. LVDS Output 312.5MHz 12kHz-20MHz 149fs

### Package Information and Recommended Land Pattern for 6-Pin LGA<sup>3</sup>



**6-Pin LGA (7x5mm)**

**Note:**

3. Package information is correct as of the publication date. For updates and most current information, go to [www.microchip.com](http://www.microchip.com).

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